SURFACE MOUNT SILICON SCHOTTKY DIODES



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMSSH-3 series devices are silicon Schottky diodes, epoxy molded in an SOT-323 surface mount package, designed for fast switching applications requiring a low forward voltage drop.



CMSSH-3: SINGLE MARKING CODE: 95D
CMSSH-3A: DUAL, COMMON ANODE
CMSSH-3C: DUAL, COMMON CATHODE
CMSSH-3S: DUAL, IN SERIES
MARKING CODE: B1D
MARKING CODE: B2D
MARKING CODE: A5D

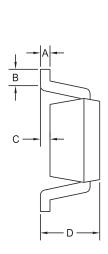
MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	30	V
Continuous Forward Current	l _F	100	mA
Peak Repetitive Forward Current	I _{FRM}	200	mA
Peak Forward Surge Current, tp=10ms	I _{FSM}	750	mA
Power Dissipation	P_{D}	275	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	455	°C/W

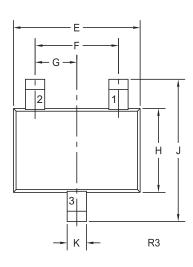
ELECTRICAL CHARACTERISTICS PER DIODE: (TA=25°C unless otherwise noted) **TEST CONDITIONS** SYMBOL TYP MAX **UNITS** V_R=25V 90 500 I_R nΑ $V_R = 25V, T_A = 100$ °C 25 100 μΑ I_R I_R=100μA 30 V BV_R $I_F=2.0mA$ 0.29 0.33 V V_{F} V_{F} I_F=15mA 0.37 0.45 I_⊏=100mA 0.51 1.00 V_{F} C_{J} V_R =1.0 V_r , f=1.0 V_r 7.0 pF $I_F = I_R = 10$ mA, $I_{rr} = 1.0$ mA, $R_L = 100$ Ω 5.0 ns t_{rr}

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SOT-323 CASE - MECHANICAL OUTLINE

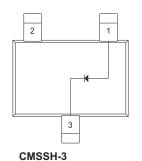




DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.002	0.008	0.05	0.20		
В	0.004	-	0.10	-		
С	-	0.004	-	0.10		
D	0.031	0.043	0.80	1.10		
E	0.071	0.087	1.80	2.20		
F	0.051		1.30			
G	0.026		0.65			
Н	0.045	0.053	1.15	1.35		
J	0.079	0.087	2.00	2.20		
K	0.008	0.016	0.20	0.40		

SOT-323 (REV: R3)

PIN CONFIGURATIONS



LEAD CODE:

- 1) Anode
- 2) NC
- 3) Cathode

MARKING CODE: 95D

D1 D2

CMSSH-3A

LEAD CODE:

- 1) Cathode D2
- 2) Cathode D1
- 3) Anode D1, D2

MARKING CODE: B1D

CMSSH-3C

2

LEAD CODE:

- 1) Anode D2
- 2) Anode D1
- 3) Cathode D1, D2

MARKING CODE: B2D

D2

CMSSH-3S

D1

D2

LEAD CODE:

3

- 1) Anode D2
- 2) Cathode D1
- 3) Anode D1, Cathode D2

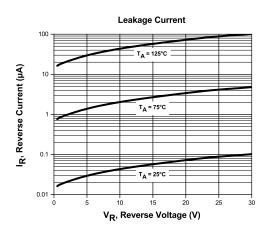
MARKING CODE: A5D

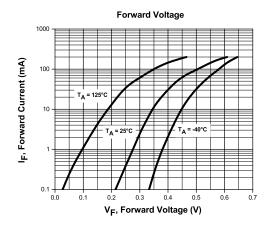
R4 (11-February 2016)

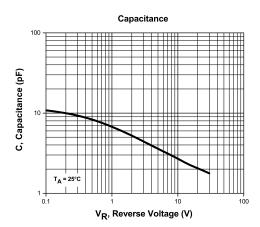
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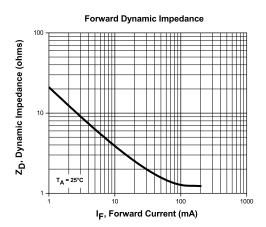


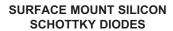
TYPICAL ELECTRICAL CHARACTERISTICS





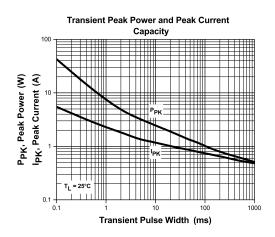


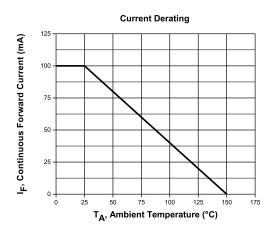


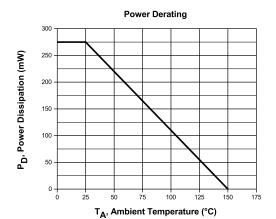




TYPICAL ELECTRICAL CHARACTERISTICS







OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- · Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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